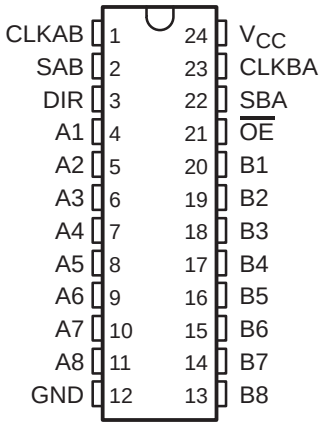
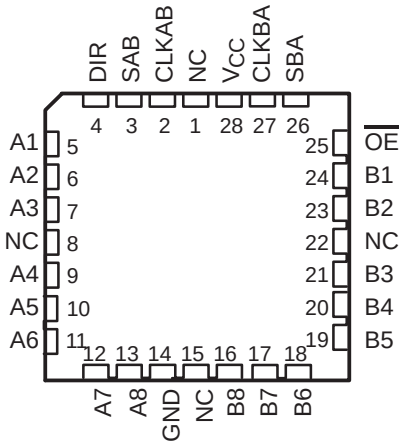
- **State-of-the-Art *EPIC*-II*B*™ BiCMOS Design Significantly Reduces Power Dissipation**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17**
- **Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25°C**
- **High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})**
- **Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), Ceramic Flat (W) Package, and Plastic (NT) and Ceramic (JT) DIPs**

SN54ABT646A . . . JT OR W PACKAGE
SN74ABT646A . . . DB, DW, NT, OR PW PACKAGE
(TOP VIEW)



SN54ABT646A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

These devices consist of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the ’ABT646A.

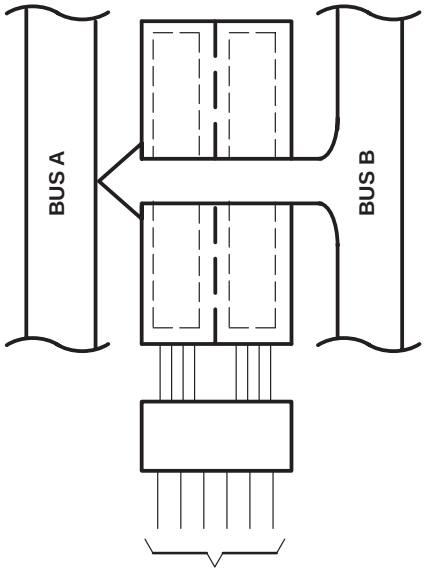
Output-enable ($\overline{OE}$) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port can be stored in either register or in both.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. The direction control (DIR) determines which bus receives data when $\overline{OE}$ is low. In the isolation mode ($\overline{OE}$ high), A data can be stored in one register and/or B data can be stored in the other register.

When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.

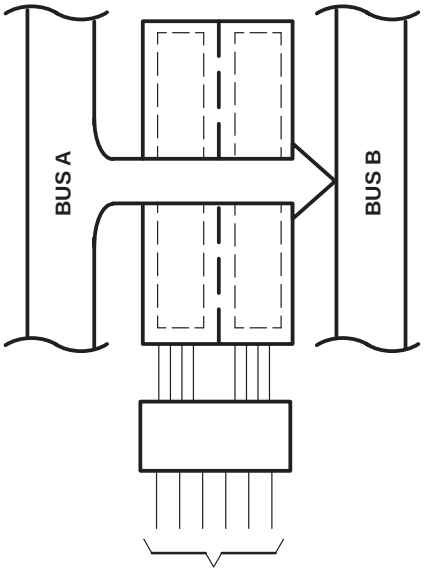
To ensure the high-impedance state during power up or power down, $\overline{OE}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT646A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT646A is characterized for operation from –40°C to 85°C.



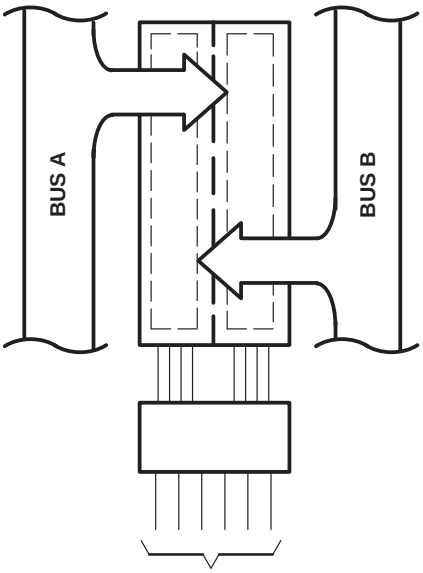
21 $\overline{OE}$	3 DIR	1 CLKAB	23 CLKBA	2 SAB	22 SBA
L	L	X	X	X	L

REAL-TIME TRANSFER
BUS B TO BUS A



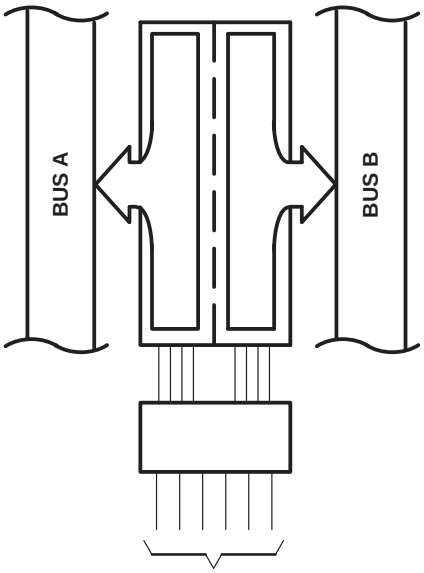
21 $\overline{OE}$	3 DIR	1 CLKAB	23 CLKBA	2 SAB	22 SBA
L	H	X	X	L	X

REAL-TIME TRANSFER
BUS A TO BUS B



21 $\overline{OE}$	3 DIR	1 CLKAB	23 CLKBA	2 SAB	22 SBA
X	X	↑	X	X	X
X	X	X	↑	X	X
H	X	↑	↑	X	X

STORAGE FROM
A, B, OR A AND B



21 $\overline{OE}$	3 DIR	1 CLKAB	23 CLKBA	2 SAB	22 SBA
L	L	X	L	X	H
L	H	L	X	H	X

TRANSFER STORED DATA
TO A AND/OR B

Pin numbers shown are for the DB, DW, JT, NT, PW, and W packages.

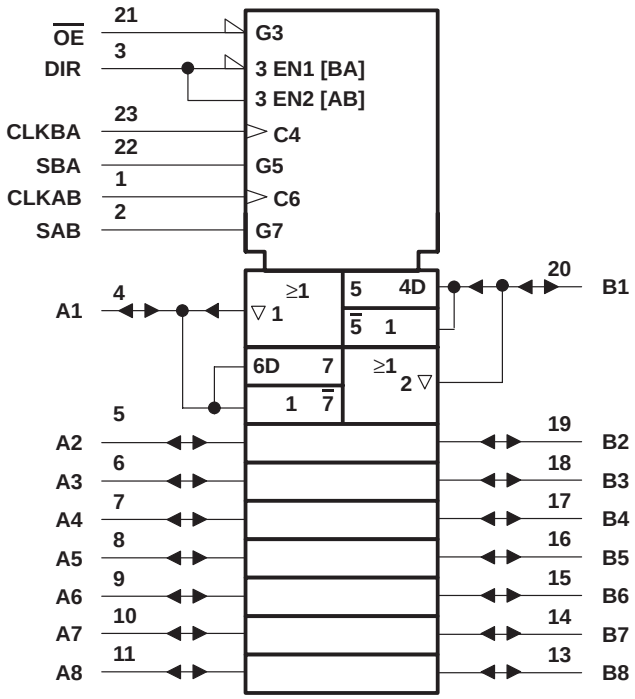
Figure 1. Bus-Management Functions

FUNCTION TABLE

INPUTS						DATA I/Os		OPERATION OR FUNCTION
$\overline{OE}$	DIR	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
X	X	↑	X	X	X	Input	Unspecified†	Store A, B unspecified†
X	X	X	↑	X	X	Unspecified†	Input	Store B, A unspecified†
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input disabled	Input disabled	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time A data to B bus
L	H	H or L	X	H	X	Input	Output	Stored A data to B bus

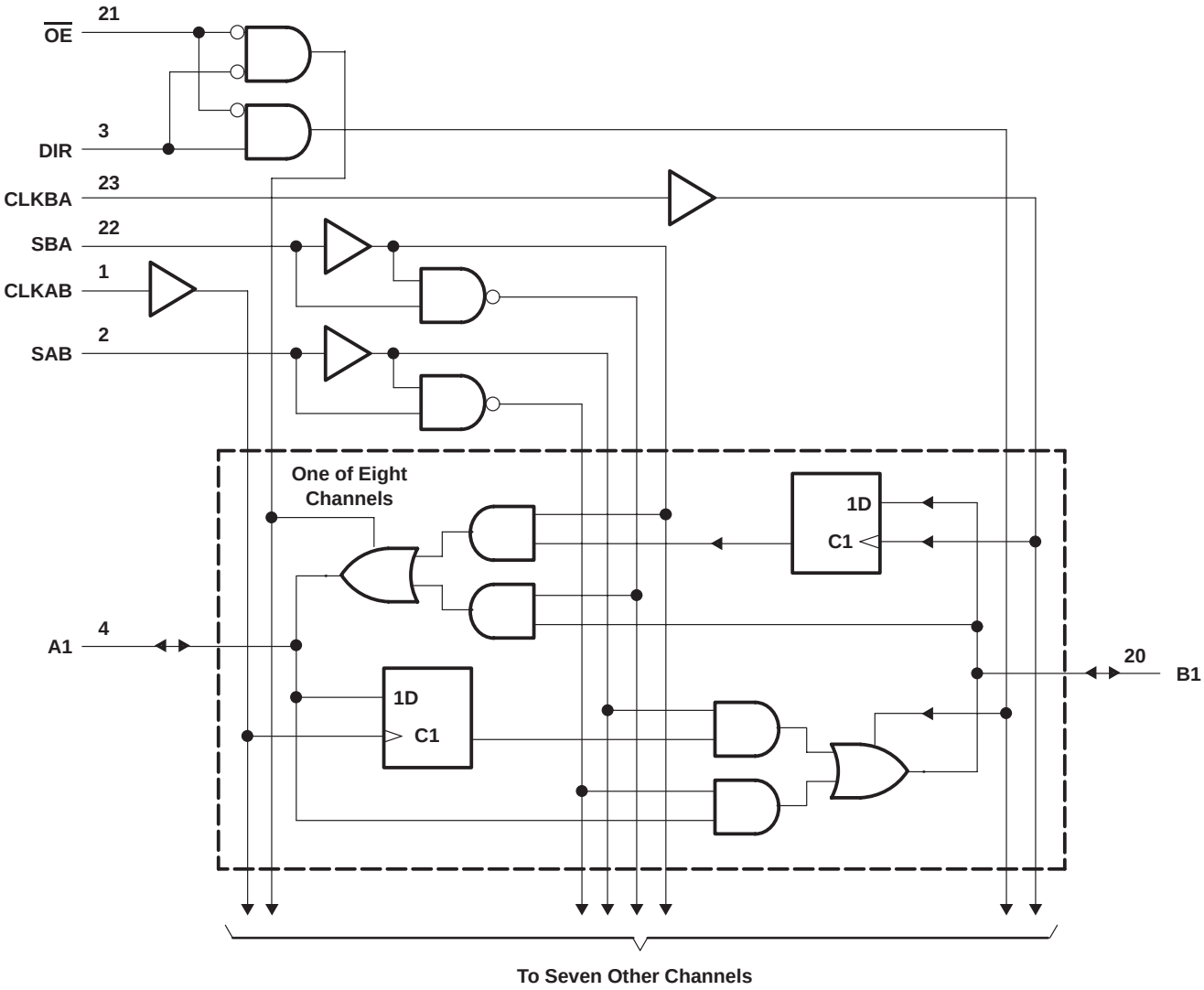
† The data-output functions may be enabled or disabled by various signals at $\overline{OE}$ and DIR. Data-input functions are always enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

logic symbol‡



‡ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the DB, DW, JT, NT, PW, and W packages.

logic diagram (positive logic)



Pin numbers shown are for the DB, DW, JT, NT, PW, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} . . . . . –0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1) . . . . . –0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, V_O . . . . . –0.5 V to 5.5 V
Current into any output in the low state, I_O: SN54ABT646A . . . . . 96 mA
SN74ABT646A . . . . . 128 mA
Input clamp current, I_{IK} (V_I < 0) . . . . . –18 mA
Output clamp current, I_{OK} (V_O < 0) . . . . . –50 mA
Package thermal impedance, θ_{JA} (see Note 2): DB package . . . . . 104°C/W
DW package . . . . . 81°C/W
NT package . . . . . 67°C/W
PW package . . . . . 120°C/W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions (see Note 3)

		SN54ABT646A		SN74ABT646A		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage	2		2		V
V_{IL}	Low-level input voltage		0.8		0.8	V
V_I	Input voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current		–24		–32	mA
I_{OL}	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		5		5	ns/V
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T_A = 25°C			SN54ABT646A		SN74ABT646A		UNIT
				MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
V_{IK}		V_{CC} = 4.5 V,	I_I = –18 mA			–1.2		–1.2		–1.2	V
V_{OH}		V_{CC} = 4.5 V,	I_{OH} = –3 mA	2.5			2.5		2.5		V
		V_{CC} = 5 V,	I_{OH} = –3 mA	3			3		3		
		V_{CC} = 4.5 V	I_{OH} = –24 mA	2			2				
			I_{OH} = –32 mA	2*					2		
V_{OL}		V_{CC} = 4.5 V	I_{OL} = 48 mA			0.55		0.55			V
			I_{OL} = 64 mA			0.55*				0.55	
V_{hys}					100						mV
I_I	Control inputs	V_{CC} = 5.5 V, V_I = V_{CC} or GND				±1		±1		±1	µA
	A or B ports					±100		±100		±100	
I_{OZH}‡		V_{CC} = 5.5 V,	V_O = 2.7 V			10§		10§		10§	µA
I_{OZL}‡		V_{CC} = 5.5 V,	V_O = 0.5 V			–10§		–10§		–10§	µA
I_{off}		V_{CC} = 0,	V_I or V_O ≤ 4.5 V			±100				±100	µA
I_{CEX}		V_{CC} = 5.5 V, V_O = 5.5 V	Outputs high			50		50		50	µA
I_O¶		V_{CC} = 5.5 V,	V_O = 2.5 V	–50	–100	–180	–50	–180	–50	–180	mA
I_{CC}		V_{CC} = 5.5 V, I_O = 0, V_I = V_{CC} or GND	Outputs high			250		250		250	µA
			Outputs low			30		30		30	mA
			Outputs disabled			250		250		250	µA
ΔI_{CC}#		V_{CC} = 5.5 V, One input at 3.4 V, Other inputs at V_{CC} or GND				1.5		1.5		1.5	mA
C_i	Control inputs	V_I = 2.5 V or 0.5 V			7						pF
C_{io}	A or B ports	V_O = 2.5 V or 0.5 V			12						pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.
† All typical values are at V_{CC} = 5 V.
‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.
§ This data sheet limit may vary among suppliers.
¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
# This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

		SN54ABT646A				UNIT
		V_{CC} = 5 V, T_A = 25°C		MIN	MAX	
		MIN	MAX			
f_{clock}	Clock frequency	0	125	0	125	MHz
t_w	Pulse duration, CLK high or low	4		4		ns
t_{su}	Setup time, A or B before CLKAB↑ or CLKBA↑	3		3.5		ns
t_h	Hold time, A or B after CLKAB↑ or CLKBA↑	1.5		1.5		ns

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

		SN74ABT646A				UNIT
		V_{CC} = 5 V, T_A = 25°C		MIN	MAX	
		MIN	MAX			
f_{clock}	Clock frequency	0	125	0	125	MHz
t_w	Pulse duration, CLK high or low	4		4		ns
t_{su}	Setup time, A or B before CLKAB↑ or CLKBA↑	3		3		ns
t_h	Hold time, A or B after CLKAB↑ or CLKBA↑	0		0		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ABT646A					UNIT
			V_{CC} = 5 V, T_A = 25°C			MIN	MAX	
			MIN	TYP	MAX			
f_{max}			125			125		MHz
t_{PLH}	CLKBA or CLKAB	A or B	2.2	4	5.1	2.2	6.7	ns
t_{PHL}			1.7	4	5.1	1.2	6.7	
t_{PLH}	A or B	B or A	1.5	3	4.3	1.5	5	ns
t_{PHL}			1.5	3.3	4.6	1.5	5.6	
t_{PLH}	SAB or SBA†	B or A	1.5	4	5.7	1.5	7.8	ns
t_{PHL}			1.5	3.6	4.9	1.5	6.2	
t_{PZH}	$\overline{OE}$	A or B	1.5	4.3	5.3	1.5	7	ns
t_{PZL}			3	5.8	8	3	10.5	
t_{PHZ}	$\overline{OE}$	A or B	1.5	3.5	5.8	1	7.3	ns
t_{PLZ}			1.5	3	4	1.5	5.7	
t_{PZH}	DIR	A or B	1.5	4.5	5.7	1.5	7.3	ns
t_{PZL}			2.5	6.5	9	2.5	11	
t_{PHZ}	DIR	A or B	1.5	3.8	6.5	1	9	ns
t_{PLZ}			1.5	3.8	4.7	1.2	6.7	

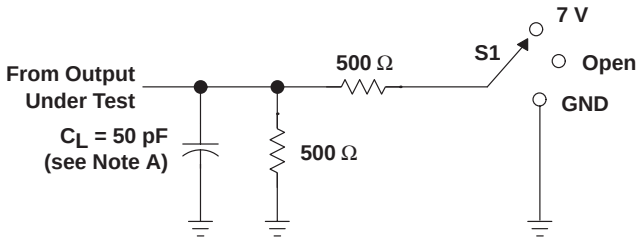
† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74ABT646A					UNIT
			V_{CC} = 5 V, T_A = 25°C			MIN	MAX	
			MIN	TYP	MAX			
f_{max}			125			125		MHz
t_{PLH}	CLKBA or CLKAB	A or B	2.2	4	5.1	2.2	5.6	ns
t_{PHL}			1.7	4	5.1	1.7	5.6	
t_{PLH}	A or B	B or A	1.5	3	4.3	1.5	4.8	ns
t_{PHL}			1.5	3.3	4.6	1.5	5.4	
t_{PLH}	SAB or SBA†	B or A	1.5	4	5.1	1.5	6.5	ns
t_{PHL}			1.5	3.6	4.9	1.5	5.9	
t_{PZH}	$\overline{OE}$	A or B	1.5	4.3	5.3	1.5	6.3	ns
t_{PZL}			3	5.8	7.4	3	8.8	
t_{PHZ}	$\overline{OE}$	A or B	1.5	3.5	4.5	1.5	5	ns
t_{PLZ}			1.5	3	4	1.5	4.5	
t_{PZH}	DIR	A or B	1.5	4.5	5.7	1.5	6.7	ns
t_{PZL}			2.5	6.5	9	2.5	9.5	
t_{PHZ}	DIR	A or B	1.5	3.8	5	1.5	5.7	ns
t_{PLZ}			1.5	3.8	4.7	1.5	6	

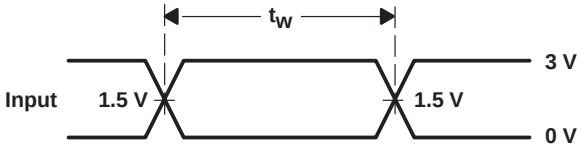
† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

PARAMETER MEASUREMENT INFORMATION

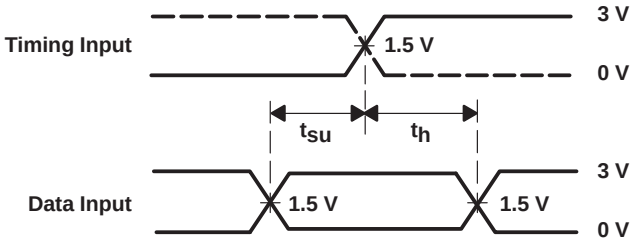


TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open

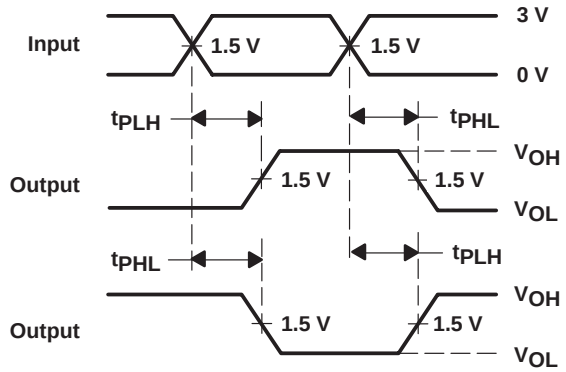
LOAD CIRCUIT



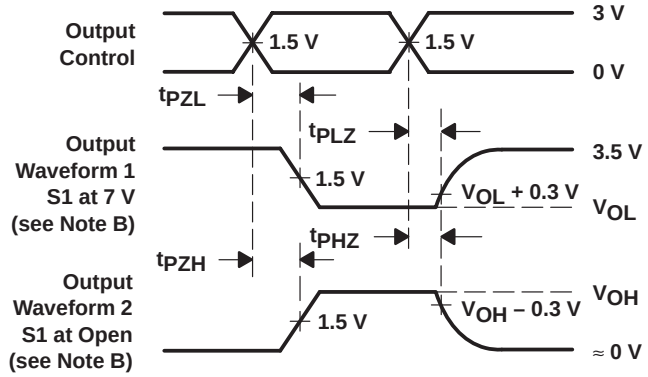
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

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SN54ABT646A, Octal Bus Transceivers And Registers With 3-State Outputs

DEVICE STATUS: **ACTIVE**

PARAMETER NAME	SN54ABT646A	SN74ABT646A
Voltage Nodes (V)	5	5
Vcc range (V)	4.5 to 5.5	4.5 to 5.5
Input Level	TTL	TTL
Output Level	TTL	TTL
No. of Outputs	8	8
Static Current		15.12

FEATURES

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- State-of-the-Art ***EPIC***-II ***B***™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25°C
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), Ceramic Flat (W) Package, and Plastic (NT) and Ceramic (JT) DIPs

DESCRIPTION

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These devices consist of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'ABT646A.

Output-enable (OE\) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port can be stored in either register or in both.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. The direction control (DIR) determines which bus receives data when OE\ is low. In the isolation mode (OE\ high), A data can be stored in one register and/or B data can be stored in the other register.

When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.

To ensure the high-impedance state during power up or power down, OE\ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT646A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT646A is characterized for operation from -40°C to 85°C.

TECHNICAL DOCUMENTS

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To view the following documents, Acrobat Reader 4.0 is required.

To download a document to your hard drive, right-click on the link and choose 'Save'.

Product Folder: SN54ABT646A, Octal Bus Transceivers And Registers With 3-State Outputs

DATASHEET

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Full datasheet in Acrobat PDF: sn54abt646a.pdf (155 KB,Rev.G) (Updated: 05/01/1997)

APPLICATION NOTES

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View Application Notes for Digital Logic

- Advanced BiCMOS Technology (ABT) Logic Characterization Information (Rev. B) (SCBA008B - Updated: 06/01/1997)
- Advanced BiCMOS Technology (ABT) Logic Enables Optimal System Design (Rev. A) (SCBA001A - Updated: 03/01/1997)
- Bus-Interface Devices With Output-Damping Resistors Or Reduced-Drive Outputs (Rev. A) (SCBA012A - Updated: 08/01/1997)
- Designing With Logic (Rev. C) (SDYA009C - Updated: 06/01/1997)
- Evaluation of Nickel/Palladium/Gold-Finished Surface-Mount Integrated Circuits (SZZA026 - Updated: 06/20/2001)
- Family of Curves Demonstrating Output Skews for Advanced BiCMOS Devices (Rev. A) (SCBA006A - Updated: 12/01/1996)
- Implications of Slow or Floating CMOS Inputs (Rev. C) (SCBA004C - Updated: 02/01/1998)
- Input and Output Characteristics of Digital Integrated Circuits (SDYA010 - Updated: 10/01/1996)
- Live Insertion (SDYA012 - Updated: 10/01/1996)
- Power-Up 3-State (PU3S) Circuits in TI Standard Logic Devices (SZZA033 - Updated: 05/10/2002)
- Quad Flatpack No-Lead Logic Packages (Rev. C) (SCBA017C - Updated: 11/22/2002)
- TI IBIS File Creation, Validation, and Distribution Processes (SZZA034 - Updated: 08/29/2002)
- Understanding Advanced Bus-Interface Products Design Guide (SCAA029, 253 KB - Updated: 05/01/1996)
- Understanding and Interpreting Texas Instruments Standard-Logic Products Data Sh (Rev. A) (SZZA036A - Updated: 02/27/2003)

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- Enhanced Plastic Portfolio Brochure (SGZB004, 387 KB - Updated: 08/19/2002)
- Logic Reference Guide (SCYB004, 1032 KB - Updated: 10/23/2001)
- MicroStar Junior BGA Design Summary (SCET004, 167 KB - Updated: 07/28/2000)
- Military Brief (SGYN138, 803 KB - Updated: 10/10/2000)
- Overview of IEEE Std 91-1984, Explanation of Logic Symbols Training Booklet (Rev. A) (SDYZ001A, 138 KB - Updated: 07/01/1996)
- Palladium Lead Finish User's Manual (SDYV001, 2041 KB - Updated: 11/01/1996)
- QML Class V Space Products Military Brief (Rev. A) (SGZN001A, 257 KB - Updated: 10/07/2002)

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- LOGIC Pocket Data Book (SCYD013, 4837 KB - Updated: 12/05/2002)

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DEVICE INFORMATION
Updated Daily

TI INVENTORY STATUS
As Of 09:00 AM GMT, 17 Apr 2003

REPORTED DISTRIBUTOR INVENTORY
As Of 09:00 AM GMT, 17 Apr 2003

ORDERABLE DEVICE	STATUS	PACKAGE TYPE | PINS	TEMP (°C)	DSCC NUMBER	PRODUCT CONTENT	BUDGETARY PRICING QTY | $US	STD PACK QTY	IN STOCK	IN PROGRESS QTY | DATE	LEAD TIME	DISTRIBUTOR COMPANY | REGION	IN STOCK	PURCHASE
5962-9457702Q3A	ACTIVE	LCCC (FK) | 28	-55 TO 125		View Contents	1KU | 12.04	1	104*	3556 | 20 May	8 WKS	Avnet | Americas	10	BUY NOW
									>10k | 27 May				
5962-9457702QKA	ACTIVE	CFP (W) | 24	-55 TO 125		View Contents	1KU | 12.04	1	11*	>10k | 20 May	8 WKS	None Reported View Distributors		
5962-9457702QLA	ACTIVE	CDIP (JT) | 24	-55 TO 125		View Contents	1KU | 8.58	1	294*	32 | 12 May	8 WKS	Avnet | Americas	141	BUY NOW
									>10k | 20 May				
SNJ54ABT646AFK	ACTIVE	LCCC (FK) | 28	-55 TO 125	5962-9457702Q3A	View Contents	1KU | 12.04	1	43*	35 | 21 Apr	8 WKS	None Reported View Distributors		

									3491 | 20 May				
									>10k | 27 May				
SNJ54ABT646AJT	ACTIVE	CDIP (JT)	24	-55 TO 125	5962-9457702QLA	View Contents	1KU | 8.58	1	1762*	>10k | 20 May	8 WKS	None Reported View Distributors	
SNJ54ABT646AW	ACTIVE	CFP (W)	24	-55 TO 125	5962-9457702QKA	View Contents	1KU | 12.04	1	222*	219 | 21 Apr	8 WKS	None Reported View Distributors	
									>10k | 20 May				

Table Data Updated on: 4/17/2003

PRODUCT FOLDER | PRODUCT INFO: FEATURES | DESCRIPTION | DATASHEETS | PRICING/AVAILABILITY/PKG | SAMPLES | APPLICATION NOTES | USER GUIDES | MORE LITERATURE

PRODUCT SUPPORT: TRAINING

SN74ABT646A, Octal Bus Transceivers And Registers With 3-State Outputs
DEVICE STATUS: **ACTIVE**

PARAMETER NAME	SN54ABT646A	SN74ABT646A
Voltage Nodes (V)	5	5
Vcc range (V)	4.5 to 5.5	4.5 to 5.5
Input Level	TTL	TTL
Output Level	TTL	TTL
No. of Outputs	8	8
Static Current		15.12

FEATURES

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- State-of-the-Art ***EPIC***-II ***B***™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25°C
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), Ceramic Flat (W) Package, and Plastic (NT) and Ceramic (JT) DIPs

EPIC-IIB is a trademark of Texas Instruments Incorporated.

DESCRIPTION

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These devices consist of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'ABT646A.

Output-enable (OE\) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port can be stored in either register or in both.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. The direction control (DIR) determines which bus receives data when OE\ is low. In the isolation mode (OE\ high), A data can be stored in one register and/or B data can be stored in the other register.

When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.

To ensure the high-impedance state during power up or power down, OE\ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT646A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT646A is characterized for operation from -40°C to 85°C.

TECHNICAL DOCUMENTS

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To view the following documents, Acrobat Reader 4.0 is required.
To download a document to your hard drive, right-click on the link and choose 'Save'.

Product Folder: SN74ABT646A, Octal Bus Transceivers And Registers With 3-State Outputs

DATASHEET

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Full datasheet in Acrobat PDF: sn74abt646a.pdf (155 KB,Rev.G) (Updated: 05/01/1997)

APPLICATION NOTES

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View Application Notes for Digital Logic

- Advanced BiCMOS Technology (ABT) Logic Characterization Information (Rev. B) (SCBA008B - Updated: 06/01/1997)
- Advanced BiCMOS Technology (ABT) Logic Enables Optimal System Design (Rev. A) (SCBA001A - Updated: 03/01/1997)
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SAMPLES

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ORDERABLE DEVICE	PACKAGE INDUSTRY (TI)	PINS	TEMP (°C)	STATUS	PRODUCT CONTENT	SAMPLES
SN74ABT646ADBR	SSOP (DB)	24	-40 TO 85	ACTIVE	View Product Content	Request Samples
SN74ABT646ADGVR	TVSOP (DGV)	24	-40 TO 85	ACTIVE	View Product Content	Request Samples
SN74ABT646ADW	SOIC (DW)	24	-40 TO 85	ACTIVE	View Product Content	Request Samples
SN74ABT646ADWR	SOIC (DW)	24	-40 TO 85	ACTIVE	View Product Content	Request Samples
SN74ABT646ANT	PDIP (NT)	24	-40 TO 85	ACTIVE	View Product Content	Request Samples

PRICING/AVAILABILITY/PKG

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Product Folder: SN74ABT646A, Octal Bus Transceivers And Registers With 3-State Outputs

DEVICE INFORMATION (Updated Daily)							TI INVENTORY STATUS (As Of 09:00 AM GMT, 17 Apr 2003)			REPORTED DISTRIBUTOR INVENTORY (As Of 09:00 AM GMT, 17 Apr 2003)		
ORDERABLE DEVICE	STATUS	PACKAGE TYPE | PINS	TEMP (°C)	PRODUCT CONTENT	BUDGETARY PRICING QTY | $US	STD PACK QTY	IN STOCK	IN PROGRESS QTY | DATE	LEAD TIME	DISTRIBUTOR COMPANY | REGION	IN STOCK	PURCHASE
SN74ABT646ADBLE	OBSOLETE	SSOP (DB) | 24	-40 TO 85	View Contents	1KU |		0*		Call**	None Reported View Distributors		
SN74ABT646ADBR	ACTIVE	SSOP (DB) | 24	-40 TO 85	View Contents	1KU | 1.21	2000	0*	896 | 23 Apr	4 WKS	DigiKey | Americas	>1k	BUY NOW
								2000 | 25 Apr				
								>10k | 12 May				
SN74ABT646ADGVR	ACTIVE	TVSOP (DGV) | 24	-40 TO 85	View Contents	1KU | 1.21	2000	0*	3606 | 01 May	4 WKS	DigiKey | Americas	>1k	BUY NOW
								>10k | 08 May				
SN74ABT646ADW	ACTIVE	SOIC (DW) | 24	-40 TO 85	View Contents	1KU | 1.21	25	0*	>10k | 30 Apr	4 WKS	Avnet | Americas	>1k	BUY NOW
										DigiKey | Americas	>1k	BUY NOW
										Arrow | Americas	180	BUY NOW
SN74ABT646ADWR	ACTIVE	SOIC (DW) | 24	-40 TO 85	View Contents	1KU | 1.21	2000	>10k*	>10k | 08 May	2 WKS	Avnet | Americas	>1k	BUY NOW
										DigiKey | Americas	>1k	BUY NOW
SN74ABT646ANSR	ACTIVE	SOP (NS) | 24		View Contents	1KU | 3.78	2000	0*	3797 | 05 May	4 WKS	None Reported View Distributors		
								>10k | 12 May				
SN74ABT646ANT	ACTIVE	PDIP (NT) | 24	-40 TO 85	View Contents	1KU | 1.21	15	0*	10 | 23 Apr	4 WKS	DigiKey | Americas	794	BUY NOW
								2730 | 30 Apr		Arrow | Americas	14	BUY NOW
								3733 | 02 May				
								>10k | 12 May				
SN74ABT646APW	ACTIVE	TSSOP (PW) | 24	-40 TO 85	View Contents	1KU | 2.38	60	0*	8580 | 16 Apr	4 WKS	Arrow | Americas	119	BUY NOW
								53 | 21 Apr				
								3847 | 01 May				
SN74ABT646APWLE	OBSOLETE	TSSOP (PW) | 24	-40 TO 85	View Contents	1KU |		0*		Call**	None Reported View Distributors		
SN74ABT646APWR	ACTIVE	TSSOP (PW) | 24	-40 TO 85	View Contents	1KU | 1.21	2000	2000*	259 | 21 Apr	4 WKS	None Reported View Distributors		
								>10k | 08 May				

Table Data Updated on: 4/17/2003

Product Folder: SN74ABT646A, Octal Bus Transceivers And Registers With 3-State Outputs